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IN THE U.S. PATENT AND TRADEMARK OFFICE Patent Application Transmittal Letter

COMMISSIONER FOR PATENTS Washington, D.C. 20231

Sir:

Transmitted herewith for filing under 37 CFR 1.53 (b) is a:

(X) Utility () Design

(X) original patent application

() continuation-in-part application

INVENTOR(S): Lup San Leong

TITLE: THERMAL MECHANICAL PLANARIZATION IN INTEGRATED GROUITS

Enclosed are:

(X) Declaration and Power of Attorney (X) signed () unsigned or partially signed

(X) 2 sheets of drawings (one set) () Associate Power of Attorney

Information Disclosure Statement and Form PTO-1449 with Cited References

.(X) Assignment (X) Recordation Form Cover Sheet (with duplicate copy)

(X) Priority Document(s)

() Statement Claiming Small Entity Status

(X) Acknowledgement Postcard

The filing-fee-has been-calculated-as-shown-below:

(1) FOR	(2) NO.		(3) NO.	(4)		(5)	
	FILED		EXTRA	RATE		AMOUNT	
TOTAL CLAIMS	20	minus 20	0	\$	18.00		\$0.00
INDEPENDENT CLAIMS	3	minus 3	0	\$	80.00		\$0.00
MULTIPLE DEPENDENT CLAIM(S)				\$	270.00		\$0.00
	BASIC FEE:			[] Design	\$	710.00
	Total of above calculations					\$	710.00
Assignment Recordation Fee						\$	40.00
TOTAL FEE							\$750.00

Charge <u>\$750.00</u> to Deposit Account <u>50-0374</u>. At any time during the pendency of this application, please charge any fees required or credit any over payment to Deposit Account <u>50-0374</u> pursuant to CFR 1.25. Additionally please charge any fees to Deposit Account <u>50-0374</u> under 37 CFR 1.16, 1.17, 1.19, 1.20, and 1.21. A duplicate copy of this sheet is enclosed.

Correspondence Address:

Respectfully Submitted,

CUSTOMER NO. 22898

Mikio Ishimaru

Registration No. 27,449

Date: May 4, 2001